

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Hiroshi Fukui Confirmation No.: 7869
Serial No.: 10/533,849
Filed: October 24, 2005
Group Art Unit: 1796
Examiner: Loewe, Robert S.
For: HEAT CONDUCTIVE SILICONE COMPOSITION

RESPONSE AFTER FINAL REJECTION

Mailstop AF
Commissioner for Patents
P.O. Box 1450
Alexandria, Virginia 22313-1450

Dear Sir:

In response to the final Office Action dated January 9, 2009, please consider the accompanying remarks. A complete listing of all claims pending in the application is included for the Examiner's convenience. This response is timely filed; thus, it is believed that no fees are presently due. Further, this response is filed within two months from the mailing date of the final Office Action.